



PRODUCT BRIEF

F200 Series

Ultra Compact Kit

HIGHLIGHTED FEATURES

- Fanless Design
- Intel® Celeron® Processor N2807(Bay Trail)
- Onboard 2G DDR3L Memory
- One mSATAII slot for SSD module
- One Mini PCIE for WiFi&BT or 3G module
- Support JAHC Technology for more custom schedule of Shutdown or Resume, saving more energy.



SPECIFICATIONS

Dimension	116.6mm*107.2mm*30mm
Processor	Intel® Celeron® Processor N2807, 2 Cores / 2 Threads, 1.58~2.16GHz, Max. TDP 4.3W
Chipset	Integrated into CPU
Display	Intel® HD Graphics Microsoft® DirectX® 11 1x HDMI (VGA Optional)
Memory	Onboard 2G DDR3L Memory
Storage	Onboard eMMC N/A (Optional 8G/16G) 1x mSATAII Port for SSD
Audio	Realtek® High Definition Audio Digital audio via HDMI connector 1x Audio out&Mic in jack on the front panel
Ethernet	1x Realtek® Gigabit Ethernet Controller 1x RJ45 port on the back panel

Wireless	NA (Optional IEEE802.11 ac/b/g/n+Bluetooth® module)
Expansion Slots	1x SIM Card slot for 3G 2x Mini-PCI Express® (Full-length for mSATAII SSD; Full-length for PCIE/USB WiFi&BT or 3G module)
Peripheral interfaces	1x USB3.0+2x USB2.0 1x JAHC Switch (Default OFF) for extended RTC 1x DC-IN Jack (5V/3A)
OS Support	Windows® 7, Windows 8.1, Android & Linux
SystemBIOS	AMI EFI BIOS; ACPI
Cooler	Fanless
Operating Temperature	0°C to +40°C